

NCE N-Channel Super Trench Power MOSFET

Description

The NCEP40T13GU uses **Super Trench** technology that is uniquely optimized to provide the most efficient high frequency switching performance. Both conduction and switching power losses are minimized due to an extremely low combination of $R_{DS(ON)}$ and Q_g . This device is ideal for high-frequency switching and synchronous rectification.

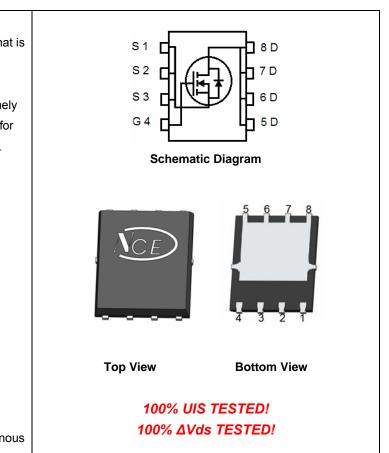
General Features

V_{DS} =40V,I_D =130A
R_{DS(ON)}=1.8mΩ (typical) @ V_{GS}=10V
R_{DS(ON)}=2.8mΩ (typical) @ V_{GS}=4.5V

- Excellent gate charge x R_{DS(on)} product(FOM)
- Very low on-resistance R_{DS(on)}
- 150 °C operating temperature
- Pb-free lead plating
- 100% UIS tested

Application

- DC/DC Converter
- Ideal for high-frequency switching and synchronous rectification



Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
NCEP40T13GU	NCEP40T13GU	DFN5X6-8L	-	-	-

Absolute Maximum Ratings (Tc=25°C unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	Vds	40	V
Gate-Source Voltage	Vgs	±20	V
Drain Current-Continuous ^(Note 1) (Silicon Limited)	Ι _D	130	А
Drain Current-Continuous(Tc=100℃)	I _D (100℃)	100	A
Pulsed Drain Current (Package Limited)	I _{DM}	400	A
Maximum Power Dissipation	PD	130	W
Derating factor		1.04	W/℃
Single pulse avalanche energy (Note 5)	E _{AS}	600	mJ
Operating Junction and Storage Temperature Range	T _J ,T _{STG}	-55 To 150	°C

Thermal Characteristic

Thermal Resistance, Junction-to-Case	$R_{ extsf{ heta}JC}$	0.96	°C /W	
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Thermal Resistance, Junction-to-Ambient^(Note 2)

 $R_{\theta JA}$

°C/W

Electrical Characteristics (Tc=25 $^\circ\!\!\mathrm{C}$ unless otherwise noted)

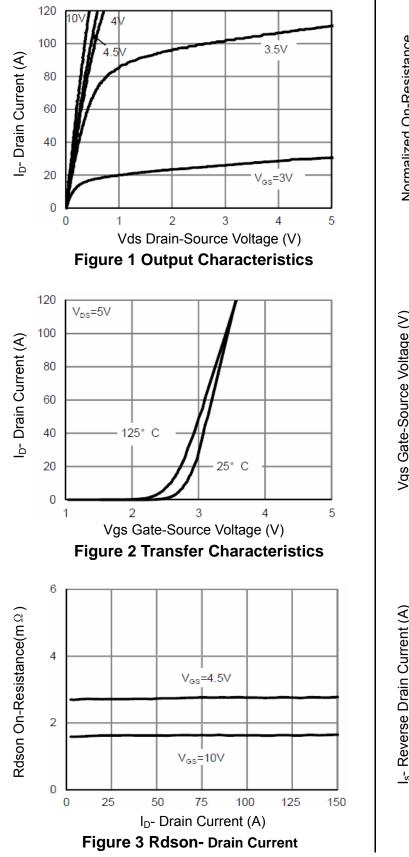
Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics						
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =250µA	40		-	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =40V,V _{GS} =0V	-	-	1	μA
Gate-Body Leakage Current	I _{GSS}	V _{GS} =±20V,V _{DS} =0V	-	-	±100	nA
On Characteristics (Note 3)						
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} ,I _D =250µA	1.2	1.7	2.2	V
Drain-Source On-State Resistance		V _{GS} =10V, I _D =65A	-	1.8	2.3	mΩ
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =4.5V, I _D =65A	-	2.8	3.6	mΩ
Gate resistance	R _G	V _{DS} =0V,V _{GS} =0V,F=1.0MHz	-	2.5	-	Ω
Forward Transconductance	g fs	V _{DS} =5V,I _D =65A	-	62	-	S
Dynamic Characteristics (Note4)	·					
Input Capacitance	C _{lss}	- V _{DS} =20V,V _{GS} =0V,	-	3334	3990	PF
Output Capacitance	C _{oss}		-	650	750	PF
Reverse Transfer Capacitance	C _{rss}	F=1.0MHz	-	57	68	PF
Switching Characteristics (Note 4)	·					
Turn-on Delay Time	t _{d(on)}		-	10	-	nS
Turn-on Rise Time	tr	V _{DD} =20V,I _D =65A	-	3	-	nS
Turn-Off Delay Time	t _{d(off)}	V _{GS} =10V,R _G =1.6Ω	-	34	-	nS
Turn-Off Fall Time	t _f		-	3	-	nS
Total Gate Charge	Qg)/ _20)// _CEA	-	49	70	nC
Gate-Source Charge	Q _{gs}	$V_{DS}=20V, I_{D}=65A,$	-	9.4		nC
Gate-Drain Charge	Q _{gd}	V _{GS} =10V	-	5		nC
Drain-Source Diode Characteristics	•	•	•			•
Diode Forward Voltage (Note 3)	V _{SD}	V _{GS} =0V,I _S =65A	-		1.2	V
Diode Forward Current	I _S		-	-	130	А
Reverse Recovery Time	t _{rr}	T _J = 25°C, I _F = I _S	-		23	nS
Reverse Recovery Charge	Qrr	di/dt = 100A/µs ^(Note3)	-		67	nC

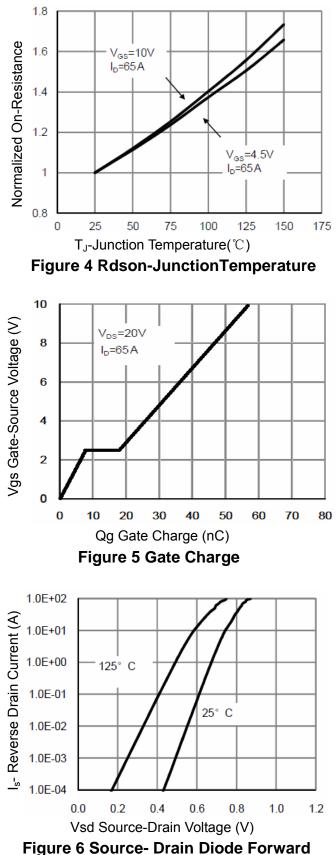
Notes:

- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- 2. Device on 40 mm x 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm2 (one layer, 70 μm thick) copper area for drain
- connection. PCB is vertical in still air.
- 3. Pulse Test: Pulse Width \leq 300µs, Duty Cycle \leq 2%.
- 4. Guaranteed by design, not subject to production
- 5. EAS condition : Tj=25 $^\circ\!\!\mathrm{C}, V_{DD}$ =20V,V_G=10V,L=0.5mH,Rg=25 $\!\Omega$





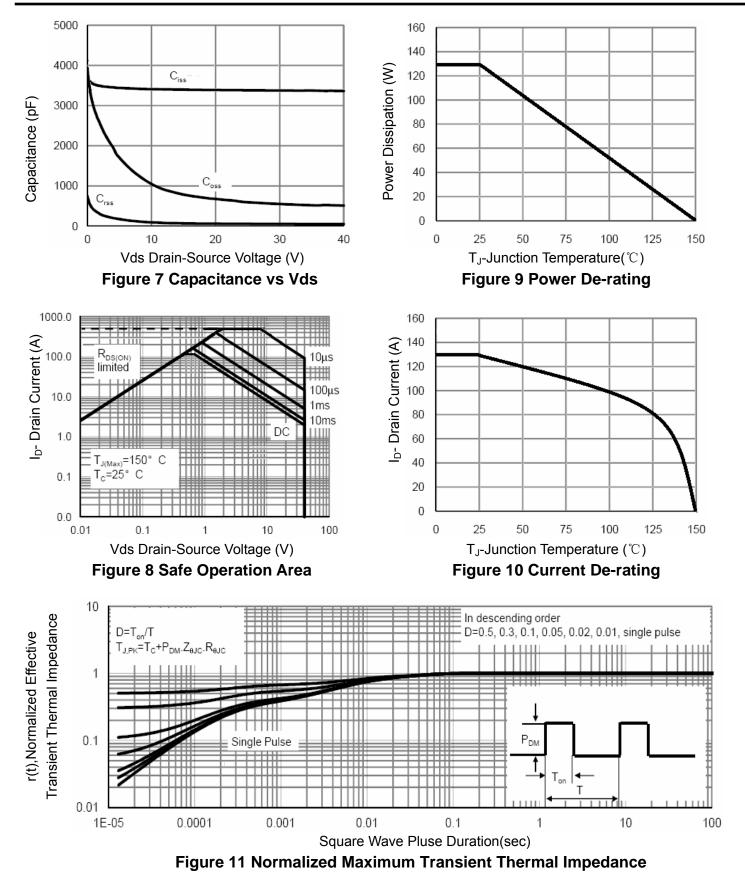






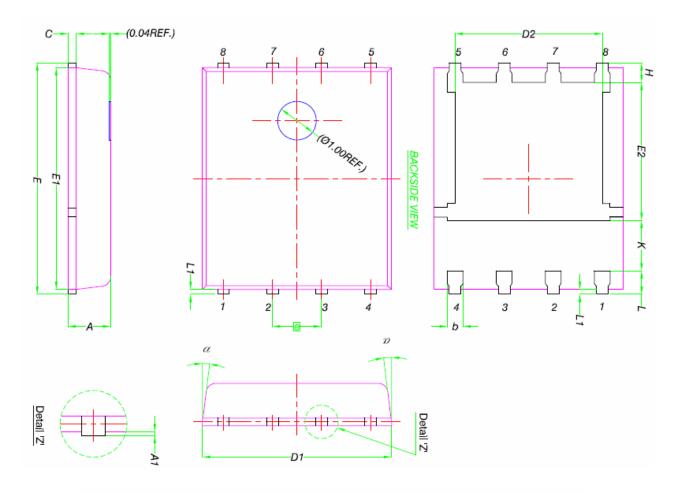
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NCEP40T13GU

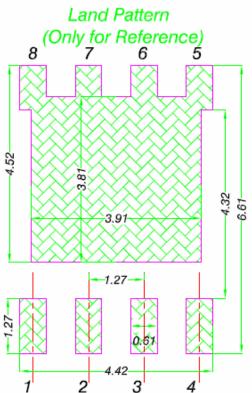




DFN5X6-8L Package Information



	MILLIMETERS			
DIM.	MIN.	NOM.	MAX.	
Α	0.90	1.00	1.10	
A1	0	-	0.05	
b	0.33	0.41	0.51	
С	0.20	0.25	0.30	
D1	4.80	4.90	5.00	
D2	3.61	3.81	3.96	
Е	5.90	6.00	6.10	
E1	5.70	5.75	5.80	
E2	3.38	3.58	3.78	
е	1.27 BSC			
Н	0.41	0.51	0.61	
к	1.10	-	-	
L	0.51	0.61	0.71	
L1	0.06	0.13	0.20	
α	0°	-	12°	





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